

# 2N3700

## NPN SILICON LOW POWER TRANSISTORS

#### **FEATURES**

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

#### **MAXIMUM RATINGS**

Rating	Symbol	2N3700	Units
Collector-Emitter Voltage	V <sub>CEO</sub>	80	V
Collector-Base Voltage	V <sub>CBO</sub>	140	V
Emitter-Base Voltage	V <sub>EBO</sub>	7.0	V
Collector Current	Ic	1.0	Α
Total device dissipation			
$T_A = +25^{\circ}C^{(1)}$	$P_D$	0.5	W
$T_c = +25^{\circ(2)}$		1.0	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +200	°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	325	°C/W
Thermal Resistance, Junction to Case	R <sub>0JC</sub>	150	°C/W

Note 1: Derate linearly 2.85mW/°C above  $T_A > +25^{\circ}C$ Note 3: Derate linearly 10.3mW/°C above  $T_C > +25^{\circ}C$ 

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Min	Max	Unit
Collector-Emitter breakdown voltage I <sub>C</sub> = 30mA	V <sub>(BR)CEO</sub>	80	-	V
Collector-Base Cutoff Current V <sub>CB</sub> = 140V	Ices	-	10	μΑ
Emitter-Base Cutoff Current $V_{EB} = 7.0V$	I <sub>EBO1</sub>	-	10	μΑ
Emitter-Base Cutoff Current V <sub>EB</sub> = 5.0V	I <sub>EBO2</sub>	-	10	μΑ
	Ices	-	10	nA
ON CHARACTERISTICS			•	
Forward Current Transfer Ratio				
$I_{C} = 150 \text{mA}, V_{CE} = 10 \text{V}$		100	300	I
$I_C = 0.1 \text{mA}, V_{CE} = 10 \text{V}$		50	300	
I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V	h <sub>FE</sub>	90	-	-
I <sub>C</sub> = 500mA, V <sub>CE</sub> = 10V		50	300	
$I_C = 1.0A, V_{CE} = 10V$		15	-	
Collector-Emitter Saturation Voltage	-		•	
I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA	V.	-	0.2	
I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA	V <sub>CE(sat)</sub>	=	0.5	V
Base Emitter Saturation Voltage I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA	V <sub>BE(sat)</sub>	-	1.1	V



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**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Min	Max	Unit
Small-Signal Forward Current Transfer Ratio $I_C = 1.0$ mA, $V_{CE} = 5.0$ V, $f = 1.0$ kHz	h <sub>fe</sub>	80	400	-
Magnitude of Small-Signal Forward Current Transfer Ratio $I_C$ = 50mA, $V_{CE}$ = 10V, $f$ = 20MHz	Ih <sub>fe</sub> I	5.0	20	-
Output Capacitance $V_{CB} = 10V$ , $I_E = 0$ , $100kHz \le f \le 1.0MHz$	C <sub>obo</sub>	-	12	pF
Output Capacitance $V_{EB} = 0.5V,  I_C = 0,  100kHz \le f \le 1.0MHz$	C <sub>ibo</sub>	-	60	pF

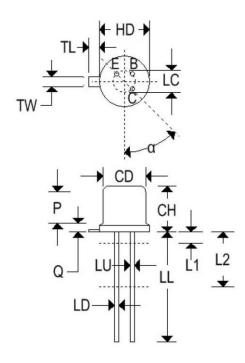
Note 3: PW =  $300\mu s$ , duty cycle  $\leq 2\%$ .

#### **SAFE OPERATION AREA**

DC Tests (T <sub>c</sub> = 25°C, 1 cycle, t = 10ms)	
Test 1	
2N3700	V <sub>CE</sub> = 10V, I <sub>C</sub> = 180mA
Test 2	
2N3700	V <sub>CE</sub> = 40V, I <sub>C</sub> = 45mA
Test 3	
2N3700	V <sub>CE</sub> = 80V, I <sub>C</sub> = 22.5mA

#### MECHANICAL CHARACTERISTICS

Case	TO-18
Marking	Alpha-numeric
Pin out	See below

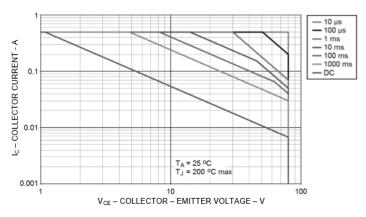


TO-18 (BJT)				
Dim	Inches		Millin	neters
	Min	Max	Min	Max
CD	0.178	0.195	4.520	4.950
CH	0.170	0.210	4.320	5.330
HD	0.209	0.230	5.310	5.840
LC	0.10	0.100 TP		40 TP
LD	0.016	0.021	0.410	0.530
LL	0.500	0.750	12.700	19.050
LU	0.016	0.019	0.410	0.480
L1	-	0.050		1.270
L2	0.250	51	6.350	1 bæ8
P	0.100	¥	2.540	-
Q		0.040		1.020
TL	0.028	0.048	0.710	1.220
TW	0.036	0.046	0.910	1.170
r	-	0.010	-	0.025
α	45	°TP	45	5°TP

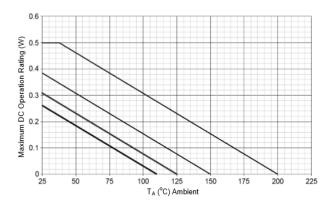


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Maximum Safe Operating Area @ TA = 25 °C

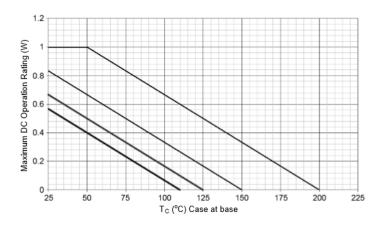


 $\frac{Temperature\text{-}Power\ Derating\ (R_{\Theta\text{JA}})}{Leads = 0.125\ inch\ (3.175mm)}$ 



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Temperature-Power Derating (Rejc)